



Product Change Notification

Change Notification #: 116905 - 00
Change Title: Intel® Xeon Phi™ Processor 7295,
Intel® Xeon Phi™ Processor 7285,
Intel® Xeon Phi™ Processor 7235,
PCN 116905-00, Product Discontinuance,
End of Life
Date of Publication: May 06, 2019

Key Characteristics of the Change:

Product Discontinuance

Forecasted Key Milestones:

Product Discontinuance Program Support Begins:	May 6, 2019
Last Product Discontinuance Order Date:	August 9, 2019
Orders are Non-Cancelable and Non-Returnable After:	August 9, 2019
Last Product Discontinuance Shipment Date:	July 31, 2020

Description of Change to the Customer:

Market demand for the products listed in the "Products Affected/Intel Ordering Codes" table below have shifted to other Intel products. The products identified in this notification will be discontinued and unavailable for additional orders after the "Last Product Discontinuance Order Date" (see "Key Milestones" above).

Customer Impact of Change and Recommended Action:

The products listed on the "Products Affected/Intel Ordering Codes" table should be managed in accordance to the "Key Milestones" listed above. These products will only remain on Intel's Corporate Assurance Process until the "Last Product Discontinuance Order Date". The "Last Product Discontinuance Order Date" is the final day for customers who carry backlog to book the Assurance Intel has granted as of the "Orders are Non-Cancellable and Non-Returnable After" (NCNR) date. NCNR date applies to both Corporate Assurance and backlog after the "Last Product Discontinuance Order Date." At this date a snapshot will be taken of all remaining backlog and/or assurance and this quantity will become non-cancellable. For all customers Corporate Assurance must be booked and shipped by the "Last Product Discontinuance Shipment Date." From date of PCN publication, interim booking and turn back deadlines or separate Letter Agreements will apply vs. the standard Corporate Assurance Process.

Products Affected / Intel Ordering Codes:

Marketing Name	Product Code	S-Spec	MM#
Intel® Xeon Phi™ Processor 7295	HJ8068303823700	S R3VD	962788
Intel® Xeon Phi™ Processor 7285	HJ8068303823800	S R3VE	962808
Intel® Xeon Phi™ Processor 7235	HJ8068303823900	S R3VF	962809

PCN Revision History:

Date of Revision:

May 6, 2019

Revision Number:

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Reason:

Originally Published PCN



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116905 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

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